

No Drawing Available.  
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Dimensions	
Footprint	5113
L	5.08mm +/-0.38mm
W	1.27mm +/-0.38mm
H	1.27mm +/-0.38mm
S	0.76mm +0.25/-0.13mm
F	1.27mm +/-0.13mm
K	0.76mm MIN
P	0.38mm MIN

Packaging Specifications	
Packaging	Bulk, Bag

General Information	
Series	T409 CWR09
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, MnO2, Molded, Military Equivalent
RoHS	No
Prop 65	<b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> .
SCIP Number	573c56ea-c4cc-4850-b749-53802fe9068f
Termination	Hot Solder Dipped
Qualifications	MIL-PRF-55365/4, CWR09 Style
AEC-Q200	No
Component Weight	146.5 mg
Notes	Note: When Option C Is Selected For Lead Material, Add An Additional 0.38mm To The Tolerances For "L", "W", "H", "K", "F" And "S".
MSL	1

Specifications	
Capacitance	2.2 uF
Capacitance Tolerance	10%
Voltage DC	15 VDC (85C), 10 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
Resistance	5.5 Ohms (100kHz 25C)
Ripple Current	117 mA (rms, 100kHz 25C)
Leakage Current	1 uA (5min 25°C)
Testing and Reliability	Surge Testing At 25C After Weibull

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